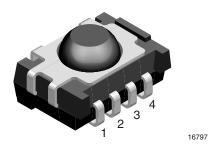


Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



www.vishay.com

MECHANICAL DATA

Pinning:

 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$

FEATURES

- Very low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage range: 2.5 V to 5.5 V
- Improved immunity against modulated light sources
- Insensitive to supply voltage ripple and noise
- Taping available for topview and sideview assembly
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912



RoHS

HALOGEN FREE GREEN

DESCRIPTION

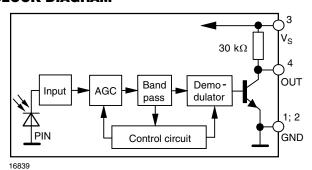
The TSOP352.., TSOP354.. series are miniaturized SMD IR receiver modules for infrared remote control systems. PIN diode and preamplifier are assembled on lead frame, the epoxy package is designed as IR filter.

The demodulated output signal can directly be decoded by a microprocessor. The TSOP352.. is compatible with all common IR remote control data formats. The TSOP354.. is optimized to suppress almost all spurious pulses from energy saving lamps but will also suppress some data signals.

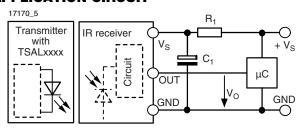
This component has not been qualified according to automotive specifications.

| PARTS TABLE | | |
|-------------------|-----------------------------------|--------------------------------|
| CARRIER FREQUENCY | STANDARD APPLICATIONS (AGC2/AGC8) | VERY NOISY ENVIRONMENTS (AGC4) |
| 30 kHz | TSOP35230 | TSOP35430 |
| 33 kHz | TSOP35233 | TSOP35433 |
| 36 kHz | TSOP35236 | TSOP35436 |
| 38 kHz | TSOP35238 | TSOP35438 |
| 40 kHz | TSOP35240 | TSOP35440 |
| 56 kHz | TSOP35256 | TSOP35456 |

BLOCK DIAGRAM



APPLICATION CIRCUIT



 $\rm R_1$ and $\rm C_1$ are recommended for protection against EOS. Components should be in the range of 33 Ω < $\rm R_1$ < 1 k Ω , C $_1$ > 0.1 μF .



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TSOP352.., TSOP354..

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| ABSOLUTE MAXIMUM RATINGS | | | | |
|-----------------------------|--------------------------|------------------|---------------------------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Supply voltage (pin 3) | | Vs | - 0.3 to + 6 | V |
| Supply current (pin 3) | | I _S | 3 | mA |
| Output voltage (pin 4) | | Vo | - 0.3 to (V _S + 0.3) | V |
| Output current (pin 4) | | Io | 5 | mA |
| Junction temperature | | T _j | 100 | °C |
| Storage temperature range | | T _{stg} | - 40 to + 100 | °C |
| Operating temperature range | | T _{amb} | - 30 to + 85 | °C |
| Power consumption | T _{amb} ≤ 85 °C | P _{tot} | 10 | mW |

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

| ELECTRICAL AND OPTI | CAL CHARACTERISTICS | $(T_{amb} = 25^\circ)$ | °C, unless o | otherwise s | pecified) | |
|----------------------------|--|------------------------|--------------|-------------|-----------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Supply current (pin 3) | $E_{V} = 0, V_{S} = 3.3 V$ | I _{SD} | 0.27 | 0.35 | 0.45 | mA |
| Supply current (pin 3) | $E_v = 40 \text{ klx, sunlight}$ | I _{SH} | | 0.45 | | mA |
| Supply voltage | | Vs | 2.5 | | 5.5 | V |
| Transmission distance | E_{v} = 0, test signal see fig. 1, IR diode TSAL6200, I_{F} = 250 mA | d | | 45 | | m |
| Output voltage low (pin 4) | $I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see fig. 1 | V _{OSL} | | | 100 | mV |
| Minimum irradiance | Pulse width tolerance: t_{pi} - 5/ f_o < t_{po} < t_{pi} + 6/ f_o , test signal see fig. 1 | E _{e min.} | | 0.15 | 0.35 | mW/m² |
| Maximum irradiance | t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see fig. 1 | E _{e max.} | 30 | | | W/m² |
| Directivity | Angle of half transmission distance | Ψ1/2 | | ± 50 | | deg |

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

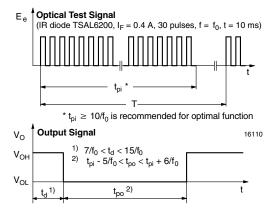


Fig. 1 - Output Active Low

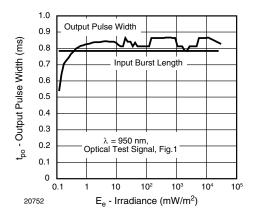


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

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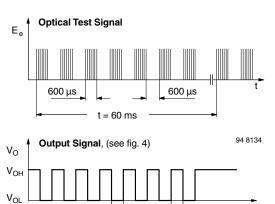


Fig. 3 - Output Function

toff

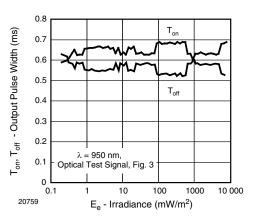


Fig. 4 - Output Pulse Diagram

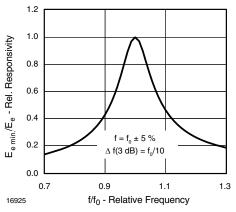


Fig. 5 - Frequency Dependence of Responsivity

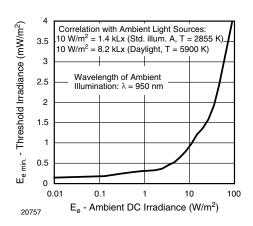


Fig. 6 - Sensitivity in Bright Ambient

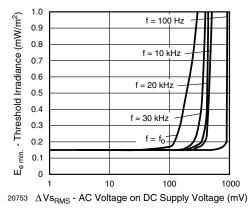


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

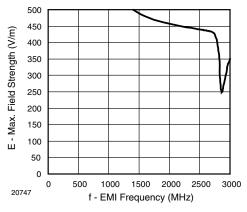


Fig. 8 - Sensitivity vs. Electric Field Disturbances

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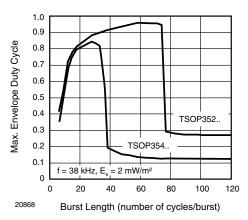


Fig. 9 - Maximum Envelope Duty Cycle vs. Burst Length

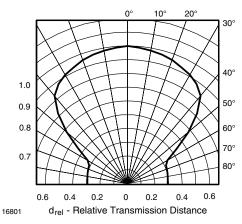


Fig. 12 - Horizontal Directivity

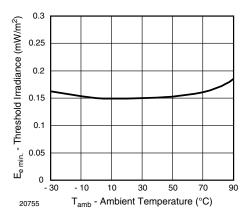


Fig. 10 - Sensitivity vs. Ambient Temperature

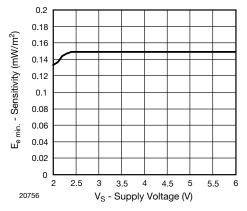


Fig. 13 - Sensitivity vs. Supply Voltage

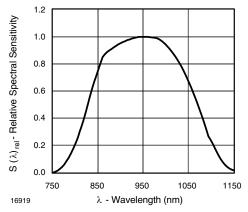


Fig. 11 - Relative Spectral Sensitivity vs. Wavelength

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SUITABLE DATA FORMAT

The TSOP352.., TSOP354.. series is designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP352.., TSOP354.. in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated noise from fluorescent lamps with electronic ballasts (see figure 14 or figure 15)

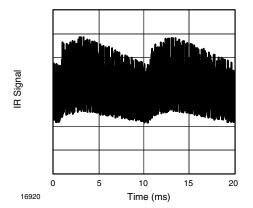


Fig. 14 - IR Signal from Fluorescent Lamp with Low Modulation

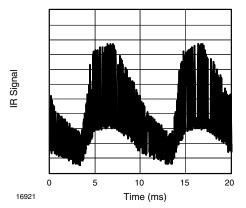


Fig. 15 - IR Signal from Fluorescent Lamp with High Modulation

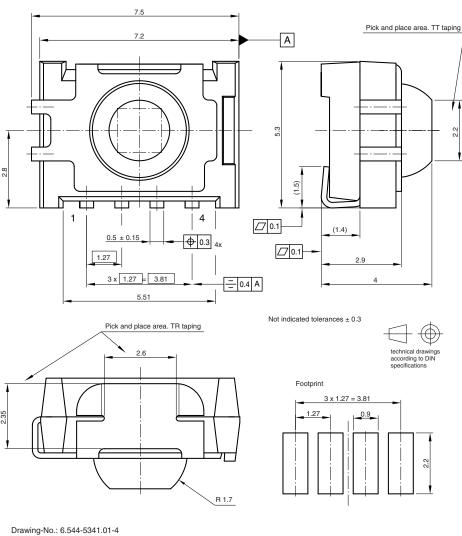
| | TSOP352 | TSOP354 |
|--|--|---|
| Minimum burst length | 10 cycles/burst | 10 cycles/burst |
| After each burst of length a minimum gap time is required of | 10 to 70 cycles ≥ 10 cycles | 10 to 35 cycles ≥ 10 cycles |
| For bursts greater than a minimum gap time in the data stream is needed of | 70 cycles > 4 x burst length | 35 cycles > 10 x burst length |
| Maximum number of continuous short bursts/second | 1800 | 1500 |
| Recommended for NEC code | yes | yes |
| Recommended for RC5/RC6 code | yes | yes |
| Recommended for Sony code | yes | no |
| Recommended for Thomson 56 kHz code | yes | yes |
| Recommended for Mitsubishi code (38 kHz, preburst 8 ms, 16 bit) | yes | no |
| Recommended for Sharp code | yes | yes |
| Suppression of interference from fluorescent lamps | Most common disturbance signals are suppressed | Even extreme disturbance signals are suppressed |

Note

For data formats with short bursts please see the datasheet for TSOP351.., TSOP353..

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PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09

ASSEMBLY INSTRUCTIONS

Reflow Soldering

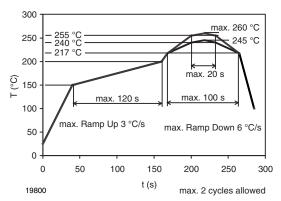
- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Excercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

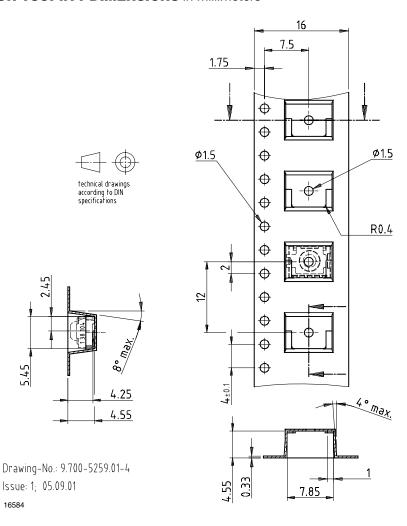
Manual Soldering

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VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

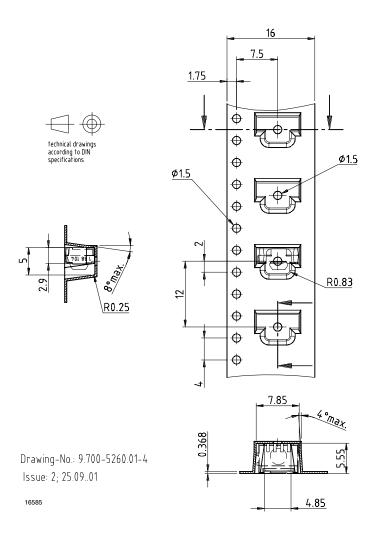


TAPING VERSION TSOP..TT DIMENSIONS in millimeters



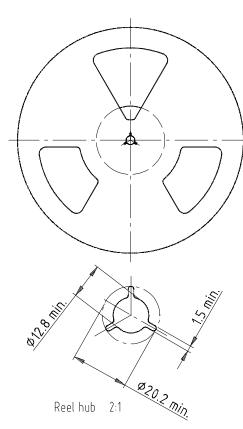
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TAPING VERSION TSOP..TR DIMENSIONS in millimeters



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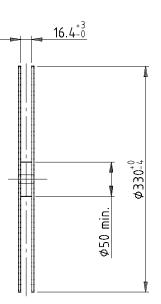
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

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Form of the leave open of the wheel is supplier specific.

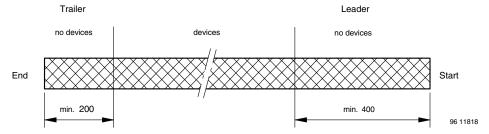
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

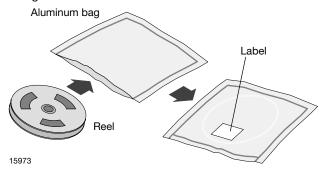


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| PLAIN WRITTING | ABBREVIATION | LENGTH |
|-----------------------|--------------|--------------|
| Item-description | - | 18 |
| Item-number | INO | 8 |
| Selection-code | SEL | 3 |
| LOT-/serial-number | BATCH | 10 |
| Data-code | COD | 3 (YWW) |
| Plant-code | PTC | 2 |
| Quantity | QTY | 8 |
| Accepted by | ACC | - |
| Packed by | PCK | - |
| Mixed code indicator | MIXED CODE | - |
| Origin | XXXXXXX+ | Company logo |
| LONG BAR CODE TOP | TYPE | LENGTH |
| Item-number | N | 8 |
| Plant-code | N | 2 |
| Sequence-number | X | 3 |
| Quantity | N | 8 |
| Total length | - | 21 |
| SHORT BAR CODE BOTTOM | TYPE | LENGTH |
| Selection-code | X | 3 |
| Data-code | N | 3 |
| Batch-number | X | 10 |
| Filter | - | 1 |
| Total length | - | 17 |

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes. An EIA JEDEC® standard JSTD-020 level 4 label is included on all dry bags.



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags



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ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Legal Disclaimer Notice

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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000